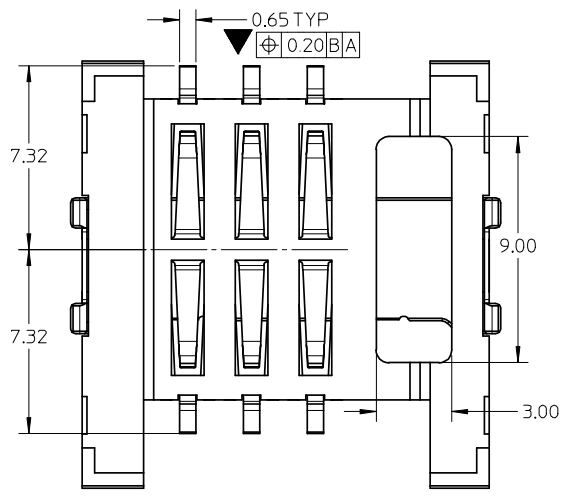
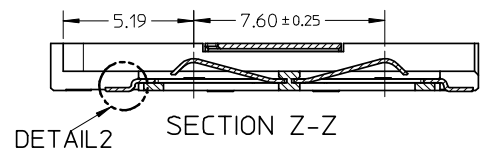
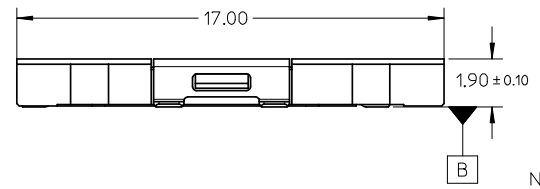
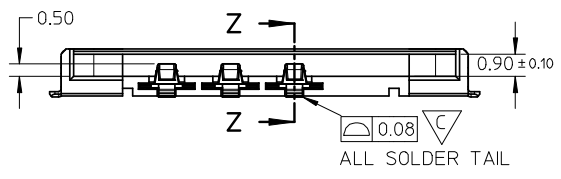


RECOMMENDED PCB LAYOUT  
DIMENSIONS GENERAL TOLERANCE : ±0.05



NOTE:  
 1 MATERIAL: HOUSING: LCP, GLASS FILLED, UL 94V-0, COLOR:BLACK, TERMINAL: PHOSPHOR BRONZE, THICKNESS:0.15MM SHELL: STAINLESS STEEL, THICKNESS:0.20MM  
 2 FINISH: TERMINAL: 50 μ MIN NICKEL PLATING OVER ALL. 15 μ MIN GOLD PLATING ON CONTACT AREA GOLD FLASH PLATING ON SOLDER AREA SHELL: GOLD FLASH OVER 50 μ MIN NICKEL ON SOLDERING AREA  
 3 PRODUCT SPECIFICATION: PS-47548-001  
 4 PACKAGE INFORMATION: PK-47548-001

RELEASED EC NO: SH2008-0563 DRWN:YWANG91 CHKD:YLZHU APPR:HWANG	2008/05/15 2008/05/19 2008/05/23	DESCRIPTION QUALITY SYMBOLS ▽=1 C=1	GENERAL TOLERANCES (UNLESS SPECIFIED)		DIMENSION STYLE	SCALE	DESIGN UNITS	THIRD ANGLE PROJECTION			
					MM ONLY	5:1	METRIC				
			mm	INCH	DRAWN BY	DATE	TITLE				
			DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS		YWANG	2007/01/16	ASSEMBLY SIM CARD CONNECTOR 1.9MM HEIGHT				
D REV	9 8 7 6 5 4 3 2 1	9 8 7 6 5 4 3 2 1	4 PLACES	± ---	± ---	CHECKED BY	DATE	MOLEX INCORPORATED SD-47548-001			
			3 PLACES	± ---	± ---	XIXU	2007/01/17				
			2 PLACES	± 0.15	± ---	APPROVED BY	DATE	MATERIAL NO.	DOCUMENT NO.	SHEET NO.	
			1 PLACE	± ---	± ---	JNCHEN	2007/01/18	475480001	SD-47548-001	1 OF 1	
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